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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/042,138	01/11/2002	Takeshi Kimura	2001_1864A	5807
513	7590 03/05/2004		EXAMINER	
WENDEROTH, LIND & PONACK, L.L.P.			FEELY, MICHAEL J	
2033 K STRE SUITE 800	EIN.W.		ART UNIT	PAPER NUMBER
	ON, DC 20006-1021		1712	

DATE MAILED: 03/05/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)	K
	10/042,138	KIMURA ET AL.	
Office Action Summary	Examiner	Art Unit	
	Michael J Feely	1712	
The MAILING DATE of this communication		ith the correspondence addre	ss
Period for Reply  A SHORTENED STATUTORY PERIOD FOR R THE MAILING DATE OF THIS COMMUNICATI  - Extensions of time may be available under the provisions of 37 C after SIX (6) MONTHS from the mailing date of this communicati	FON.  FR 1.136(a). In no event, however, may a on.  , a reply within the statutory minimum of thin period will apply and will expire SIX (6) MOI statute, cause the application to become A	reply be timely filed ty (30) days will be considered timely. VTHS from the maiting date of this commi BANDONED (35 U.S.C. § 133).	unication.
Status			
Responsive to communication(s) filed on     This action is <b>FINAL</b> . 2b)     Since this application is in condition for all closed in accordance with the practice units.	This action is non-final.  lowance except for formal mat	• •	erits is
Disposition of Claims			
4)  Claim(s) 1-8 is/are pending in the applica 4a) Of the above claim(s) is/are wit 5)  Claim(s) is/are allowed. 6)  Claim(s) 1-8 is/are rejected. 7)  Claim(s) is/are objected to. 8)  Claim(s) are subject to restriction a	hdrawn from consideration.		
Application Papers	•		
9) The specification is objected to by the Exact 10) The drawing(s) filed on 11 January 2002 is Applicant may not request that any objection is Replacement drawing sheet(s) including the country.  The oath or declaration is objected to by the second seco	s/are: a)⊠ accepted or b)⊡ on the drawing(s) be held in abeyate correction is required if the drawing	nce. See 37 CFR 1.85(a). g(s) is objected to. See 37 CFR	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for for a) All b) Some * c) None of:  1. Certified copies of the priority docu 2. Certified copies of the priority docu 3. Copies of the certified copies of the application from the International B * See the attached detailed Office action for	ments have been received. ments have been received in A e priority documents have been sureau (PCT Rule 17.2(a)).	Application No  received in this National Sta	age
Attachment(s)  1) Notice of References Cited (PTO-892)  2) Notice of Draftsperson's Patent Drawing Review (PTO-943)  Information Disclosure Statement(s) (PTO-1449 or PTO/542)  Paper No(s)/Mail Date 0702.	18) Paper No	Summary (PTO-413) (s)/Mail Date Informal Patent Application (PTO-15 	i2)

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## **DETAILED ACTION**

## Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 1-8 are rejected under 35 U.S.C. 102(b) as being anticipated by Ikemoto et al. (JP 10-214741). A machine translation of this reference, provided by the JPO website, has been relied upon for the following rejection. All citations should be directed towards the translation document.

Regarding claims 1 and 2, Ikemoto et al. disclose: (1) a ceramic device (Abstract) comprising: a ceramic element (Abstract); an external electrode on said ceramic element (Abstract; paragraph 0034; Figure 1); and a protective layer on said ceramic element and external electrode (Abstract; paragraphs 0013-0028), said protective layer being formed through impregnating a compound into said ceramic element and external electrode (paragraphs 0042-0047; Figures 2d and 3a) and through dehydration condensation (Abstract; paragraphs 0017 and 0022), said compound being expressed by a formula of:

$$R-C_nH_{2n}-Si-(OR')_3$$

where R is an epoxy group, alkyl group, aryl group, perfluoroaryl group, or mixture thereof, n is a natural number, and R' is an alkyl group having 1 to 4 carbon atoms, hydrogen, or halogen atom (Abstract; paragraphs 0013-0028), wherein at least one R' is hydrogen (Abstract;

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paragraphs 0017 and 0022); and (2) wherein ceramic element is a sintered dielectric material (Abstract; paragraphs 0038-0041).

Regarding claims 3 and 4, Ikemoto et al. disclose: (3) a ceramic device (Abstract) comprising: a ceramic element (Abstract); an external electrode on said ceramic element (Abstract; paragraph 0034; Figure 1); and a protective layer on said ceramic element and external electrode (Abstract; paragraphs 0013-0028), said protective layer being formed through impregnating a compound into said ceramic element and external electrode (paragraphs 0042-0047; Figures 2d and 3a) and through dehydration condensation (Abstract; paragraphs 0017 and 0022), said compound being expressed by a formula of:

$$R-O-C_nH_{2n}-Si-(OR')_3$$

where R is an epoxy group, alkyl group, aryl group, perfluoroaryl group, or mixture thereof, n is a natural number, and R' is an alkyl group having 1 to 4 carbon atoms, hydrogen, or halogen atom (Abstract; paragraphs 0013-0028), wherein at least one R' is hydrogen (Abstract; paragraphs 0017 and 0022); and (4) wherein ceramic element is a sintered dielectric material (Abstract; paragraphs 0038-0041).

Regarding claims 5 and 6, Ikemoto et al. disclose: (5) a method of manufacturing a ceramic device (Abstract) comprising the steps of: providing ceramic electronic device including a ceramic element (Abstract) and an external electrode on said ceramic element (paragraphs 0038-0042; Figures 2a-d); plating the external electrode (paragraph 0049); immersing the ceramic electronic device into a solution containing a compound expressed by the formula:

$$R-C_nH_{2n}-Si-(OR')_3$$

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where R is an epoxy group, alkyl group, aryl group, perfluoroaryl group, or mixture thereof, n is a natural number, and R' is an alkyl group having 1 to 4 carbon atoms, hydrogen, or halogen atom (paragraphs 0042-0047; Figure 3a), wherein at least one R' is hydrogen (Abstract; paragraphs 0017 and 0022); and taking out the immersed ceramic device from the solution and subjecting the ceramic device to heat treatment (paragraph 0048; Figure 3b); and (6) wherein said step of providing the ceramic electronic device includes the sub-steps of: forming the ceramic element through stacking an internal electrode and a ceramic layer (paragraph 0039-0041; Figure 2a-c); and forming external electrodes on the ceramic sheet, being electrically connected to the internal electrode (paragraph 0042; Figure 2d).

Regarding claims 7 and 8, Ikemoto et al. disclose: (7) a method of manufacturing a ceramic device (Abstract) comprising the steps of: providing ceramic electronic device including a ceramic element (Abstract) and an external electrode on said ceramic element (paragraphs 0038-0042; Figures 2a-d); plating the external electrode (paragraph 0049); immersing the ceramic electronic device into a solution containing a compound expressed by the formula:

$$R-O-C_nH_{2n}-Si-(OR')_3$$

where R is an epoxy group, alkyl group, aryl group, perfluoroaryl group, or mixture thereof, n is a natural number, and R' is an alkyl group having 1 to 4 carbon atoms, hydrogen, or halogen atom (paragraphs 0042-0047; Figure 3a), wherein at least one R' is hydrogen (Abstract; paragraphs 0017 and 0022); and taking out the immersed ceramic device from the solution and subjecting the ceramic device to heat treatment (paragraph 0048; Figure 3b); and (8) wherein said step of providing the ceramic electronic device includes the sub-steps of: forming the ceramic element through stacking an internal electrode and a ceramic layer (paragraph 0039-

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0041; Figure 2a-c); and forming external electrodes on the ceramic sheet, being electrically connected to the internal electrode (paragraph 0042; Figure 2d).

It should be noted that regarding claims 1-8, at least one hydroxyl group would have inherently been present during the disclosed step of dehydration condensation. This is simply another way of expressing the sequence of hydrolysis and condensation of the hydrolyzable silane.

## Communication

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Michael J Feely whose telephone number is 571-272-1086. The examiner can normally be reached on M-F 8:30 to 5:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Vasu Jagannathan can be reached on 571-272-1119. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Michael J. Feely Patent Examiner Art Unit 1712

February 23, 2004